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A NEW SIMPLE DEVICE TO ESTIMATE THERMOPHYSICAL PROPERTIES OF INSULATING MATERIALS

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ABSTRACT

The method described here is to measure thermal conductivity of super insulating materials. The principle is based on a simple transient experiment and a single temperature measurement. The main idea is to control the heat flux diffusion in the sample by the adjunction of a semi infinite highly conductive medium.

An analytical 3D model for transient heat transfer was developed. The resolution of the inverse problem enables the thermophysical properties of insulating materials to be identified.

Introduction

Designing an experimental device to estimate thermophysical conductive properties of superinsulating materials is generally difficult.

1D permanent transfer in the case of a guarded hot box apparatus (see Mumaw, 1973) requires many precautions (regulated heat sink, fluxmeters, regulated guard ring etc.).

The use of the transient flash method (see Parker et al, 1961; Degiovanni, 1977) to measure thermal diffusivity is also difficult due to the influence of heat losses around the sample. Some authors (see Martin et al, 1994) have tried to improve the experiment by adding 2 metal plates on either side of the sample. However, the experiment becomes more complicated and the influence of the lateral heat losses is only attenuated.

Lastly, the popular hot wire method (see Carslaw and Jaeger, 1959) remains easier to implement. However, even if the cylindrical semi infinite medium assumption avoids the problem of considering heat losses and the ends of the medium, some loss effects are possible at the ends of the wire. Moreover, large temperature gradients around the wire, due to the geometry, can introduce some estimation errors in the case of non linear transfer.

The new device proposed here tries to combine all the advantages of the previous methods. The main idea is to control the heat flux diffusion inside the insulating sample by addition of a highly conductive metal support. No regulated heat sink and flux meter is then needed. A probe similar to the hot wire system is used to measure only one temperature evolution on a planar heating device. Therefore, the transfer becomes quite 1D and steady, even if a model considering 3D geometry and transient state is necessary.

This device is then a simple complementary approach of hot wire method in order to comfirm this kind of measurement.

The principle of the experiment is first explained and a 3D model is proposed. Asymptotic expansions give the first step of a 3 parameters estimation method.

Experimental validation is shown with convenient appropriate size recommendations.

Modelling



The device described in figure 1 can be modelised using the following system:

FIG 1 Scheme of the device and Main geometrical parameters of the device

Transfer inside the heating layer (medium 1):

This layer is metallic and considered to be infinitely thin. Thus temperature distribution is assumed to be uniform versus z-direction. It yelds then:

$$(\rho c_p)_1 e_1 \frac{\partial T_1^*}{\partial t} = Q + \Phi_2(z = e_1)$$
⁽¹⁾

Where Q is the Joule effect heat flux and $\Phi_2(z = e_1)$ describes the heat flux penetrating inside the insulating sample (medium 2).

Transfer inside the insulating sample (medium 2) and inside the conductive medium (medium 3):

Heat transfert is here assumed to be purely conductive and the sample isotropic. It yields then in cylindrical coordinates:

$$\left(\frac{\partial^2 T_i^*}{\partial r^2} + \frac{1}{r} \frac{\partial^2 T_i^*}{\partial r^2}\right) + \frac{\partial^2 T_i^*}{\partial z^2} = \frac{1}{a_i} \frac{\partial T_i^*}{\partial t} \quad i = 2,3$$
(2)

with flux and temperature continuity at interfaces between media 1 and 2, and media 2 and 3.

Flux is assumed to be null at r=R.

Initially, the whole system is assumed to be at uniform temperature To. A new variable is then considered such as $T_i = T_i^* - To$.

To write the previous system in a less complex form, Laplace and Hankel transforms yiels :

$$\theta_i(\alpha_n, z, p) = \int_0^R \int_0^\infty T_i(r, z, t) e^{-pt} J_0(\alpha_n r) r \, dt dr \tag{3}$$

Then equation (2) becomes an ordinary differential equation:

$$\frac{d^2\theta_i}{dz^2} = \left(\frac{p}{a_i} + \alpha_n^2\right)\theta_i \tag{4}$$

with α_n : roots of a transcendental equation such as: $J_1(\alpha_n R) = 0$. We use the mumerical approximation of α_n :

$$\alpha_o = 0 \text{ and } \alpha_n R = n\pi + \frac{\pi}{4} - \frac{3}{(8n\pi + \frac{\pi}{4})}$$

with heat flux definition such as:

$$\Psi_{i}(\alpha_{n}, p, z) = -\lambda_{i} \frac{d\theta_{i}(\alpha_{n}, p, z)}{dz}$$
(5)

Expressions (4) and (5) are then equivalent to a quadripole presentation (see Batsale et al, 1994) such as :

$$\frac{d}{dz}\begin{bmatrix}\theta_{i}(\alpha_{n}, p, z)\\\psi_{i}(\alpha_{n}, p, z)\end{bmatrix} = \begin{bmatrix}0 & -1/\lambda_{i}\\-(\rho c_{p})_{i}p + \alpha_{n}^{2} & 0\end{bmatrix}\begin{bmatrix}\theta_{i}(\alpha_{n}, p, z)\\\psi_{i}(\alpha_{n}, p, z)\end{bmatrix}$$
(6)

The solution of (6) gives a simple relationship between temperature and flux vector at the limits of each medium such as:

$$\begin{bmatrix} \theta_{i}(\alpha_{n}, p, \sum_{j=l}^{i-l} e_{j}) \\ \psi_{i}(\alpha_{n}, p, \sum_{j=l}^{i-l} e_{j}) \end{bmatrix} = \begin{bmatrix} A_{i} & B_{i} \\ C_{i} & D_{i} \end{bmatrix} \begin{bmatrix} \theta_{i}(\alpha_{n}, p, \sum_{j=l}^{i} e_{j}) \\ \psi_{i}(\alpha_{n}, p, \sum_{j=l}^{i} e_{j}) \end{bmatrix}$$
(7-a)

with

$$A_{i} = D_{i} = \cosh(K_{i}e_{i}) \qquad B_{i} = \frac{\sinh(K_{i}e_{i})}{\lambda_{i}K_{i}}$$

$$C_{i} = \lambda_{i}K_{i}\sinh(K_{i}e_{i}) \qquad and \ K_{i} = \sqrt{\frac{p}{a_{i}} + \alpha_{n}^{2}}$$
(7-b)

Medium 3 is considered as semi-infinite so that the transformed temperature distribution is under the form:

$$\theta_3(\alpha_n, p, z) = \theta_3(\alpha_n, p, e_1 + e_2) exp(-K_3)z$$
(8)

Then it yields the following:

$$\theta_{3}(\alpha_{n}, p, z) = \frac{1}{\lambda_{3}K_{3}} exp(-K_{3}z)$$
and $\psi_{3}(\alpha_{n}, p, z)\Big|_{z=e_{1}+e_{2}} = -\lambda_{3} \frac{d\theta_{3}(\alpha_{n}, p, z)}{dz}\Big|_{z=e_{1}+e_{2}} = \lambda_{3}K_{3}\theta_{3}(\alpha_{n}, p, e_{1}+e_{2})$
(9)

The entire system can be described in transformed space as:

$$\begin{bmatrix} \theta_1(\alpha_n, p, 0) \\ \Psi_1(\alpha_n, p, 0) \end{bmatrix} = \begin{bmatrix} 1 & 0 \\ (\rho c_p)_1 e_1 p & 1 \end{bmatrix} \begin{bmatrix} A_2 & B_2 \\ C_2 & D_2 \end{bmatrix} \begin{bmatrix} \theta_3(\alpha_n, p, e_1 + e_2) \\ \Psi_3 = \lambda_3 K_3 \theta_3(\alpha_n, p, e_1 + e_2) \end{bmatrix}$$
(10)

The transformed temperature measured on the heating plate is then:

$$\theta_{1}(\alpha_{n}, p, 0) = \frac{\{A_{2} + B_{2}\lambda_{3}K_{3}\}\psi_{1}(\alpha_{n}, p, 0)}{C_{2} + A_{2}(\rho c_{p})_{1}e_{1}p + \lambda_{3}K_{3}\{B_{2}(\rho c_{p})_{1}e_{1}p + D_{2}\}}$$
(11)

Such an expression is rather complex and can be inverted in real space by numerical computation. Nevertheless, some asymptotic expansions can give some insights to the physical behaviour of the system.

Physical Behaviour of the System Through Asymptotic Assumptions of the Model

<u>Asymptotic behaviour of (11) when $((\rho c_p)_i e_i = 0, t \to \infty \text{ and } \lambda_3 \to \infty)$ </u>

Expression (11) yields then:

$$\theta_{1}(\alpha_{n}, p, 0) = \frac{th(\alpha_{n}e_{2})}{\lambda_{2}\alpha_{n}} \frac{QbJ_{1}(\alpha_{n}b)}{p\alpha_{n}}$$
(12)

In real space a relationship between the temperature measured at the center of the plate (r=0) gives:

$$T(0,0,t) = \frac{e_2 Q b^2}{\lambda_2 R^2} + \frac{2 Q b^2}{\lambda_2 R^2} \sum_{n=1}^{\infty} \frac{t h(\alpha_n e_2)}{b \alpha_n^2} \frac{J_1(\alpha_n b)}{J_0^2(\alpha_n R)} = R_c Q$$
(13)

- Where Rc is the constriction resistance between the heating plate and the semi-infinite cool plate. The definition of Rc is then :

$$Rc = \left(\frac{e_2}{\lambda_2} + \frac{2}{\lambda_2} \sum_{n=1}^{\infty} \frac{th(\alpha_n e_2)}{b\alpha_n^2} \frac{J_J(\alpha_n b)}{J_0^2(\alpha_n R)}\right) \frac{b^2}{R^2}$$
(14)

- $\lambda_3 \rightarrow \infty$ is assumed to be equivalent to Dirichlet zero temperature condition at z=e1+e2+e3 depth.

Asymptotic behaviour of (11) when $((\rho c_p)_1 e_1 = 0 \text{ and } (\rho c_p)_2 e_2 = 0)$

$$\theta_{I}(\alpha_{n}, p, 0) = \frac{1}{\sqrt{\lambda_{3}(\rho c_{p})_{3}}\sqrt{p}} \frac{QbJ_{I}(\alpha_{n}b)}{p\alpha_{n}} + \frac{th(\alpha_{n}e_{2})}{\lambda_{2}\alpha_{n}} \frac{QbJ_{I}(\alpha_{n}b)}{p\alpha_{n}}$$
(15)

In real space, a relationship between the temperature measured at the center of the plate (r=0) gives:

$$T(0,0,t) = \frac{Qb^2}{R^2 \sqrt{\pi} \sqrt{\lambda_3 (\rho c_p)_3}} \sqrt{t} + RcQ$$
(16)

Such an approximated expression as (16) is more convenient to understand the physical evolution of temperature T(r=0,z=0,t) (see an example of comparison between expression (11) and (16) on figure 2).



FIG 2 Example of comparison between expressions (11) and (16).

The first term depends only on the properties of medium 3. The second term (constant) depends only on thermal conductivity λ_2 and geometrical parameters

A first estimation method can be deduced:

* estimation of
$$\frac{Q}{\sqrt{\lambda_3(\rho c_p)_3}}$$
 with the slope versus \sqrt{t} (see figure 2).

* estimation of RcQ with the origin ordinate (extrapolated).

* the value of $(\rho c_p)_2$ is fixed at $(\rho c_p)_1$ to begin the numerical estimation.

Since the Joule effect energy is estimated by electrical measurement on the heating resistance, estimation of effusivity $\sqrt{\lambda_3(\rho c_p)_3}$ of medium 3 is a good way to verify the conservation of the heat flow inside the system.

This non dependance between thermophysical properties of media 2 and 3 can constitute the basic step to implement a classical numerical estimation method which minimize the norm between experimental values and exact expression (11). We have used a Nelder Mead minimization algorithm (see Press et al, 1986).

Experiment and Results

Description of the device:

The scheme of the device is given on figure 1-a.

The heating probe is made with two thin foil resistances (MINCO type [15]) in which a K-type thermocouple is inserted to measure the temperature evolution of the probe. An electric generator supplies an step power exitation to the probe. The thermocouple signal is recorded on a digital oscilloscope.

The only precaution with the samples is to respect the size, parallelism and symmetry.

A 10 cm thick brass cylinder is used as a conductive semi infinite medium.

The validation of the device has been made using other classical methods (such as hot wire, hot plane,...).

Experimental temperature evolution is given on figure (3) and nominal values are given in table 1.



FIG 3 Experimental temperature evolution.

TABL	.E 1
Nominal	values:

Excitation heat flux	Q=444.48 Wm ⁻²
Thermal conductivity of medium 3	$\lambda_3 = 150 \text{ W.m}^{-1}.\text{K}^{-1}$

Volumetric thermal capacity of medium 3	$(\rho c_p)_3 = 3.6 \ 10^6 \ J.m^{-3}.K^{-1}$
Volumetric thermal capacity of medium 3	$(\rho c_p)_1 = 3.26 \ 10^6 \ J.m^{-3}.K^{-1}$
Lateral dimensions 1	$b=4.5 \ 10^{-3} \ m$
Lateral dimensions of medium 2 and 3	$R=5 \ 10^{-2} m$
Thickness of medium 1	$e_1 = 2.10^{-4} m$
Thickness of medium 2	$e_2 = 5.4.10^{-3} m$

The material used is a sample of furnace thermal insulation: Isosilikat (table 2).

TABLE 2	,
Results	

	Hot Wire method	Constructor data	Our method
λ (W/mK)	0.086	0.088	0.087
$(\rho c_p)_2 (J.m^{\cdot 3}.K^{\cdot 1})$		2.33 10 ⁵	2.69 10 ⁵
$E_3(J.m^{-2}.K^{-1}s^{-1/2})$		2.32 10 ⁴	2.23 10 ⁴

We have observed that the rough estimation from the expression is very accurate.

Calculation of the constriction resistance Rc (14), gives an excellent first estimation of the thermal conductivity λ_2 . In the proposed case, we obtain $\lambda_2=0.087$ W/mK. We begin the numerical estimation with this first value.

Study of measurement noise influence :

This problem can be studied with the linear least square approach (Beck et Arnold, 1977). The measurement temperature $\hat{T}(t)$ is linked to real temperature T(t) by the following expression :

$$\hat{T}(t) = T(t) + e_T(t) \tag{17}$$

Where $e_t(t)$ is a random variable called « measurement error ». The mean value is assumed to be zero and stantard deviation to be constant for each t considered, such as (from expression (16)).

$$\begin{bmatrix} \hat{T}_{i} \\ \cdot \\ \cdot \\ \cdot \\ \hat{T}_{n} \end{bmatrix} = \begin{bmatrix} \sqrt{t_{i}} & I \\ \cdot & \cdot \\ \cdot \\ \cdot \\ \sqrt{t_{n}} & I \end{bmatrix} \begin{bmatrix} \beta_{i} \\ \beta_{2} \end{bmatrix} = \begin{bmatrix} X \begin{bmatrix} \beta_{i} \\ \beta_{2} \end{bmatrix}$$
(18)

Where [X] is the sensitive matrix and :

$$\beta_{1} = \frac{Qb^{2}}{R^{2}\sqrt{\pi}\sqrt{\lambda_{3}(\rho c_{p})_{3}}}$$

$$\beta_{2} = RcQ$$
(19)

The optimal estimation is then :

$$\hat{\boldsymbol{\beta}} = ([X]^T [X])^{-1} [X]^T \hat{\boldsymbol{T}} \text{ with } \hat{\boldsymbol{\beta}} = [\boldsymbol{\beta}_1, \boldsymbol{\beta}_2]^T$$
(20)

The estimation parameters vector can be written : $\hat{\beta} = \beta + e_{\beta}$, where β is the real parameters vector and e_{β} is « the estimation parameters error »

Then e_{β} is linked to e_{T} by the relationship :

$$cov[e_{\beta}] = ([X]^{T}[X])^{-1}\sigma^{2}$$
⁽²¹⁾

with X sensitivities matrix and σ stantard deviation on noise measurement :

$$cov[e_T] = \sigma^2[I] \tag{22}$$

With linear expression (16), we obtain the covariance matrix (figure 4) :

$$cov \begin{bmatrix} e_{\beta_1} \\ e_{\beta_2} \end{bmatrix} = \begin{bmatrix} 2.6510^{-5} & -10^{-3} \\ -10^{-3} & 4.0210^{-2} \end{bmatrix}$$
(23)



FIG 4

Result of the asymptotic assumption (16).

These values indicate a very good occuracy. So we can estimate parameters but we can also know the estimation error on these parameters. Therefore slight systematic errors can occur with the determination of the other remaining thermophysical properties such as λ_2 , ρc_2 , etc ...

Remarks:

* Limitations relative to thermal contact resistances :

One of the main assumptions here is to neglect the thermal contact resistances between layers 1, 2 and 3. This induces a limitation with the samples to be measured. One criterion can be established:

$$\frac{e_2}{\lambda_2} >> 10^{-4} \ W^{-1} m^2 K \tag{24}$$

* Choice of the sizes

We plot on figure 5, the evolution T_{con}/T where T_{conv} is the temperature evolution at r=0 and z=e in the case of convective losses on the lateral face of the sample is considered.

 $b^*=b/R$, $e_2^*=e_2/R$ and biot number Bi=h*R/ λ =16.7



FIG 5 T_{con}/T fonction of b and e_2

In order to fit with the previous assumption (adiabacity on lateral faces), it is important that the dimensions of the system be R >> b and $b \approx e_2$. In practise, we take b=e2=R/10.

Conclusion

The new device proposed here is complementary of the classical hot wire method. Our method remains simple, but we can control the heat flux diffusion in the sample.

We have shown that the calculation of the constriction resistance in the studied material quickly gives an exellent first estimation of the thermal conductivity. We can estimate the thermal conductivity and the volumic heat capacity with a classical numerical estimation which minimizes the norm beetween experimental result and complete model. We can also estimate the error on the parameters.

Nomenclature

A, B, C, D	Quadripole elements
Q	Excitation heat flux
Rc	Contact thermal resistance
Т	Temperature
а	Thermal diffusivity
r, z	Spatial coordinate
р	Laplace parameter
t	Time
Ε	Thermal effusivity
b, R	Lateral dimensions
е	Thickness
λ	Thermal conductivity
Ψ	Laplace-Hankel flux
θ	Laplace-Hankel temperature
ρc_p	Volumetric thermal capacity
α	Hankel parameter
i	indice relative to i-layer

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